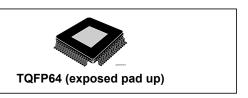
FDA2100LV



2 x 180 W / 1 x 300 W PWM digital input power amplifier with built-in diagnostics features and step-up driver

Data brief - production data



Features

- Integrated 105 dB D/A conversion
- I²S & TDM digital input (3.3/1.8 V)
- Input sampling frequency: 44.1kHz, 48 kHz, 96 kHz, 192 kHz
- · Step-up driver included
- EMI control for FM/AM compatibility
- Dithering possibility
- Capable to operate down to 6 V (e.g. "start-stop")
- 6 V 35 V operating range ($R_1 = 8 \Omega$)
- · Low component count output low-pass filter
- Output low-pass filter included in the feedback
- Low radiation function (LRF)
- · High output power capability
 - 2 x 80 W/4 Ω @ 25 V, 1 kHz, 10 % THD
 - 2 x 120 W/4 Ω @ 30 V, 1 kHz, 10 % THD
 - 1 x 150 W/2 Ω @ 25 V, 1 kHz, 10 % THD
- Full I²C bus driving (3.3/1.8 V):
 - I²C bus digital diagnostics (including DC and AC load detection); AC and DC loudspeaker diagnostic
- Very flexible fault detection through integrated diagnostic
- Protected against several kinds of misconnections
- · Offset detector (play or mute mode)
- Two independent short circuit protections
- Clipping detector
- C-MOS compatible enable pin (3.3/5 V)
- ESD protection
- Package: TQFP64 exposed pad up

Description

The FDA2100LV is a new BCD technology dual bridge class D amplifier, specially intended for car radio applications.

Thanks to the BCD6-SOI (Silicon On Insulation) technology it is possible to integrate a high performance D/A converter together with powerful MOSFET output amplifier working in class D, to get outstanding efficiency with respect to the standard class AB.

The D/A conversion on board allows the performance to reach an outstanding 110 dB S/N ratio with 105 dB of dynamic range. The feedback loop includes the output L-C low-pass filter, allowing superior frequency response linearity and lower distortion independently of the inductor and capacitor quality.

A full diagnostics array communicates the status of each speaker through the I²C bus. The possibility to control the device by means of the I²C bus makes FDA2100LV very flexible.

Thanks to the solutions implemented to solve the EMI problems, the device can be used in the standard single DIN car-radio box together with the tuner.

A built-in step-up driver allows up to 150 W output power with the standard 14 V supply voltage.

The FDA2100LV is moreover compliant to the most recent OEM specifications for low voltage operation (so called 'start-stop' battery profile during engine stop), helping car manufacturers to reduce the overall emissions and thus contributing to environment protection.

Table 1. Device summary

Order code	Package	Packing	
FDA2100LV	TQFP64 (e.p.u.)	Tray	
FDA2100LV-T	1Q1104 (e.p.u.)	Tape & reel	

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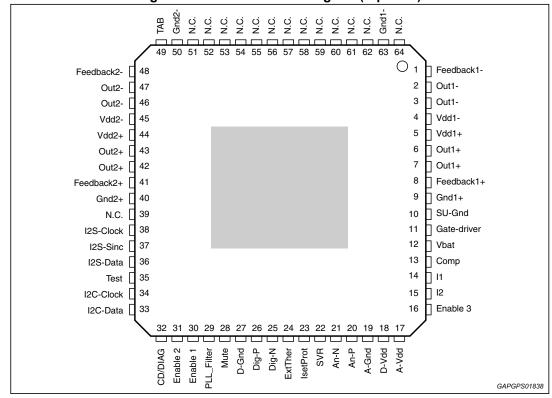
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Block diagram and pins description

Figure 1. Block diagram C-Clock 2C-Data D/DIAG Enable 3 Enable 2 D-Gnd I
Dig-P I
Dig-N I
D-Vdd I
SVR
A-Vdd An-N
An-P
A-Gnd IsetProt
ExtTher PLL I2C - 8 Feedba - 7 Out1+ - 6 Out1+ - 3 Out1-- 2 Out1-- Feedba PWM I2S-Clock Transresistance Power amplifier I2S-Sinc I2S-data Feedback1-Interpolation & Noise Shaping Feedback2+ 43 Out2+ SU-Gnd →42 Out2+ →48 Out2-→47 Out2-Gate-driver Vbat Comp Feedback2-12 TAB Gnd1 Vdd1 Vdd1-Gnd1 Vdd2-Vdd2 Gnd2-Gnd2-GAPGPS01837





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Table 2. Pins list description

Pin#	Pin name	Function		
64	N.C.	Not connected		
63	Gnd1-	Channel 1, half bridge power ground -		
51-62	N.C.	Not connected		
50	Gnd2-	Channel 2, half bridge power ground -		
49	TAB	TAB connection		
48	Feedback2-	Channel 2 half bridge feedback -		
47	Out2-	Channel 2 half bridge output -		
46	Out2-	Channel 2 half bridge output -		
45	Vdd2-	Channel 2 half bridge power supply -		
44	Vdd2+	Channel 2 half bridge power supply +		
43	Out2+	Channel 2 half bridge output +		
42	Out2+	Channel 2 half bridge output +		
41	Feedback2+	Channel 2 half bridge feedback +		
40	Gnd2+	Channel 2, half bridge power ground +		
39	N.C.	Not connected		
38	I2S-Clock	I2S/TDM clock Input		
37	I2S-Sinc	I2S/TDM sinc Input		
36	I2S-Data	I2S/TDM data Input		
35	Test	Test pin (do not use)		
34	I2C-Clock	I2C data Clock		
33	I2C-Data	I2C data input		
32	CD/DIAG	Clip detector and diagnostic output: over-current protection, thermal warning, offset detection		
31	Enable 2	Chip enable 2		
30	Enable 1	Chip enable 1		
29	PLL_Filter	PLL filter network		
28	Mute	Mute input (6 μA source current)		
27	D-Gnd	Digital ground		
26	Dig-P	Positive digital supply V(svr)+1.65 (internally generated)		
25	Dig-N	Negative digital supply V(svr)-1.65 (internally generated)		
24	ExtTher	External thermal protection input		
23	IsetProt	Current protection resistor setting		
22	SVR	Supply voltage ripple rejection capacitor		
21	An-N	Negative analog supply V(svr)-1.65 (internally generated)		
20	An-P	Positive analog supply V(svr)+1.65 (internally generated)		

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Table 2. Pins list description (continued)

Pin#	Pin name	Function		
19	A-Gnd	Analog ground		
18	D-Vdd	Digital power supply		
17	A-Vdd	Analog power supply		
16	Enable 3	Chip enable 3		
15	12	Step-up current limiting reference		
14	I1	Step-up current limiting input		
13	Comp	Step-up compensation input		
12	Vbat	Power supply (battery)		
11	Gate-driver	External PowerMOS gate drive output		
10	SU-Gnd	Step-up power ground		
9	Gnd1+	Channel 1, half bridge power ground +		
8	Feedback1+	Channel 1 half bridge feedback +		
7	Out1+	Channel 1 half bridge output +		
6	Out1+	Channel 1 half bridge output +		
5	Vdd1+	Channel 1 half bridge power supply +		
4	Vdd1-	Channel 1 half bridge power supply -		
3	Out1-	Channel 1 half bridge output -		
2	Out1-	Channel 1 half bridge output -		
1	Feedback1-	Channel 1 half bridge feedback -		



Device overview FDA2100LV

2 Device overview

The FDA2100LV is a fully digital single chip class D amplifier with high immunity to the demodulation filter effects, built-in diagnostic functions and step-up driver. The high integration level and the on-board signal processing allow an excellent audio performance to be achieved. Thanks to the digital input and a feedback strategy in the power stage that make the amplifier robust with respect to the output filter non-idealities, the number and size of the external components are minimized.

Differently from the typical PWM switching amplifiers, a new feedback technique is adopted by FDA2100LV. The LC filter is included in the feedback loop making the amplifier highly insensitive to the characteristics of such a demodulator group. This solution optimizes the system performance in terms of THD and frequency response. Regardless of the big phase shifting introduced by the output filter the device shows a great phase margin for any load condition.

A number of features has also been included to reduce EMI, making the system compliant with the stringent limits typical of automotive applications and the fully digital approach provides a strong GSM immunity.

The FDA2100LV includes digital I²C and I²S interfaces, internal 20 bits DAC conversion, digital signal processing for interpolation and noise shaping, step-up driver, internal PLL for a pure clock generation and self diagnostic functions and automatic detection of wrong load connections or variation of the load with respect to the expected one.

In particular, considering diagnostic feature, the FDA amplifiers family provides different functions to detect several possible fault conditions. Any warning information will be stored in the I²C interface and kept until the first I²C bus reading operation. The main FDA2100LV's diagnostic features are the following ones:

- Load detection
- Under/over voltage evens
- Chip over temperature
- Digital input offset
- Output clipping
- Over temperature of an external component (i.e. step-up DMOS) through a suitable NTC external sensor
- · Output current digital acquisition



FDA2100LV Package information

3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.

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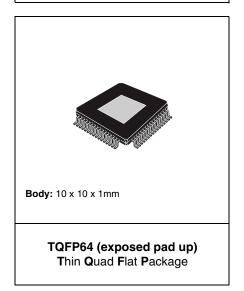
Figure 3. TQFP64 (exposed pad up) mechanical data and package dimensions

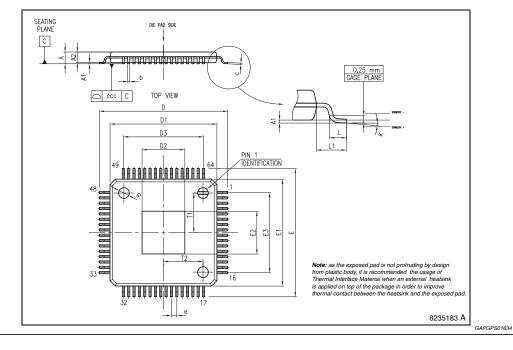
DIM.	mm				inch	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α			1.090			0.0429
A1	-0.040		0.040	-0.0016		0.0016
A2	0.950	1.000	1.050	0.0374	0.0394	0.0413
b	0.170	0.220	0.270	0.0067	0.0087	0.0106
С	0.090		0.200	0.0035		0.0079
D	11.800	12.000	12.200	0.4646	0.4724	0.4803
D1	9.800	10.000	10.200	0.3858	0.3937	0.4016
D2 ⁽¹⁾	2.000			0.0787		
D3		7.500			0.2953	
Е	11.800	12.000	12.200	0.4646	0.4724	0.4803
E1	9.800	10.000	10.200	0.3858	0.3937	0.4016
E2 ⁽¹⁾	2.000			0.0787		
E3		7.500			0.2953	
е		0.500			0.0197	
L	0.450	0.600	0.750	0.0177	0.0236	0.0295
L1		1.000			0.0394	
k		3.500	7.000		0.1378	0.2756
CCC			0.080			0.0031
R		1.000			0.0394	
T1-T2		5.250			0.2067	
(1) The size of exposed pad is variable depending of leadframe de- sign pad size						

⁽¹⁾ The size of exposed pad is variable depending of leadframe design pad size. End user should verify "D2" and "E2" dimensions for each design user should verify "D2" and "E2" dimensions for each design user should verify "D2".

vice application

OUTLINE AND MECHANICAL DATA





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Revision history FDA2100LV

4 Revision history

Table 3. Document revision history

Date	Revision	Changes
11-Oct-2013	1	Initial release.

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